



HeiTech

HeiTech Padu Berhad

(310628-D)

(Incorporated in Malaysia under the Companies Act, 1965)



PUBLIC ISSUE

OF

12,500,000

NEW ORDINARY SHARES OF RM1.00 EACH
AT AN ISSUE PRICE OF RM2.50
PER NEW ORDINARY SHARE
PAYABLE IN FULL ON APPLICATION
AND

PLACEMENT

OF

4,000,000

ORDINARY SHARES OF RM1.00 EACH
AT A PLACEMENT PRICE OF
RM2.50 PER ORDINARY SHARE
PAYABLE IN FULL ON APPLICATION
BY THE NOMINATED PLACEEES

PURSUANT TO THE LISTING OF
HEITECH PADU BERHAD
ON THE MAIN BOARD OF
THE KUALA LUMPUR STOCK EXCHANGE

Adviser & Managing Underwriter



Aseambankers

Aseambankers Malaysia Berhad (15938-H)

“FOR INFORMATION CONCERNING CERTAIN RISK FACTORS WHICH SHOULD BE CONSIDERED BY PROSPECTIVE INVESTORS, SEE “RISK FACTORS” IN SECTION 3”

This prospectus is dated 9 October 2000